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- Qualified for Automotive Applications
- Customer-Specific Configuration Control Can Be Supported Along With Major-Change Approval
- Complete PWM Power Control Circuitry
- Completely Synchronized Operation
- Internal Undervoltage Lockout Protection
- Wide Supply Voltage Range
- Internal Short-Circuit Protection
- Oscillator Frequency . . . 500 kHz Max
- Variable Dead Time Provides Control Over Total Range
- Internal Regulator Provides a Stable 2.5-V Reference Supply
- Available in Q-Temp Automotive
 HighRel Automotive Applications
 Configuration Control / Print Support
 Qualification to Automotive Standards

NOTE 1: Contact Texas Instruments for details. Q100 qualification data available on request.

PW PACKAGE (TOP VIEW) 16 ¶ REF CT RT [15 SCP 2 ERROR ∫1IN+ 14 2IN+ ERROR 3 13 2IN- AMPLIFIER 2 AMPLIFIER 1 1 1IN-∏ 1FEEDBACK 1 5 12 1 2FEEDBACK 1DTC ∏ 6 11 7 2DTC 10 7 20UT 10UT 7 9 П ∨сс GND [

description

The TL1451A incorporates on a single monolithic chip all the functions required in the construction of two pulse-width-modulation (PWM) control circuits. Designed primarily for power-supply control, the TL1451A contains an on-chip 2.5-V regulator, two error amplifiers, an adjustable oscillator, two dead-time comparators, undervoltage lockout circuitry, and dual common-emitter output transistor circuits.

The uncommitted output transistors provide common-emitter output capability for each controller. The internal amplifiers exhibit a common-mode voltage range from 1.04 V to 1.45 V. The dead-time control (DTC) comparator has no offset unless externally altered and can provide 0% to 100% dead time. The on-chip oscillator can be operated by terminating RT and CT. During low V_{CC} conditions, the undervoltage lockout control circuit feature locks the outputs off until the internal circuitry is operational.

The TL1451AQ-Q1 is characterized for operation from -40°C to 125°C.

AVAILABLE OPTIONS

	PACKAGED DEVICES	
TA	TSSOP (PW) [†]	
	(1 44)	
-40°C to 125°C	TL1451AQPWRQ1	

†The PW package is only available left-end taped and reeled.



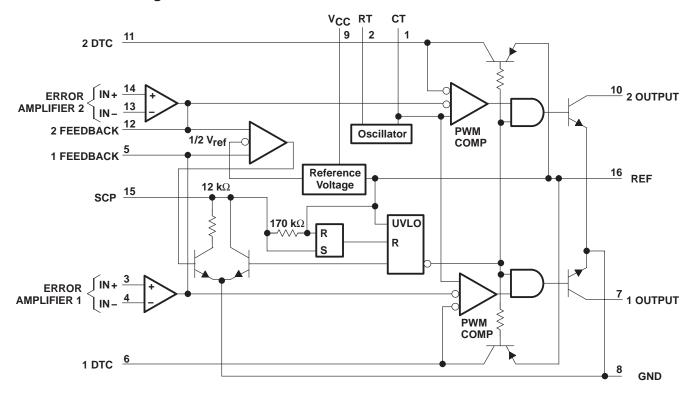
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



processing does not necessarily include testing of all pa

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functional block diagram



COMPONENT COUNT

Resistors	65
Capacitors	8
Transistors	105
JFETs	18



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absolute maximum ratings over operating free-air temperature range†

Supply voltage, V _{CC}	51 V
Amplifier input voltage, V _I	
Collector output voltage, VO	
Collector output current, IO	21 mA
Continuous power total dissipation	
Operating free-air temperature range, T _A	–40°C to 125°C
Storage temperature range, T _{stq}	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{\scriptsize A}} \leq 25^{\circ}\mbox{\scriptsize C}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	T _A = 125°C POWER RATING
PW	838 mW	6.7 mW/°C	536 mW	436 mW	168 mW

recommended operating conditions

	MIN	MAX	UNIT
Supply voltage, V _{CC}	3.6	50	V
Amplifier input voltage, V _I	1.05	1.45	V
Collector output voltage, VO		50	V
Collector output current, IO		20	mA
Current into feedback terminal		45	μΑ
Feedback resistor, R _F	100		kΩ
Timing capacitor, C _T	150	15000	pF
Timing resistor, R _T	5.1	100	kΩ
Oscillator frequency	1	500	kHz
Operating free-air temperature, T _A	-40	125	°C



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electrical characteristics over recommended operating free-air temperature range, V_{CC} = 6 V, f = 200 kHz (unless otherwise noted)

reference section

DADAMETED	TEST CONDITIONS		7		LINUT	
PARAMETER	TEST CONDITION	JN5	MIN	TYP [†]	MAX	UNIT
0		T _A = 25°C	2.4	2.5	2.6	.,
Output voltage (pin 16)	I _O = 1 mA	T _A = MIN and 125°C	2.35	2.46	2.65	V
Output voltage change with temperature				-0.63%	±4%‡	
Input voltage regulation	V _{CC} = 3.6 V to 40 V	T _A = 25°C		2.0	12.5	
		T _A = 125°C		0.7	15	mV
		$T_A = MIN$		0.3	30	
		T _A = 25°C		1	7.5	
Output voltage regulation $I_{O} = 0.7$	I _O = 0.1 mA to 1 mA	T _A = 125°C		0.3	14	mV
		$T_A = MIN$		0.3	20	
Short-circuit output current	V _O = 0		3	10	30	mA

 $[\]uparrow$ All typical values are at T_A = 25°C unless otherwise indicated.

undervoltage lockout section

242445	TEGE COURTEONS	TL1451AQ			
PARAMETER	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
	T _A = 25°C		2.72		
Upper threshold voltage (V _{CC})	T _A = 125°C		1.7		V
	$T_A = MIN$		3.15		
Lower threshold voltage (V _{CC})	T _A = 25°C		2.6		
	T _A = 125°C		1.65		V
	$T_A = MIN$		3.09		
	T _A = 25°C	80	120		
Hysteresis (V _{CC})	T _A = 125°C	10	50		mV
	$T_A = MIN$	10	60		
Reset threshold voltage (V _{CC})	T _A = 25°C	1.5			
	T _A = 125°C	0.95			V
	T _A = MIN	1.5			

 $^{^{\}dagger}$ All typical values are at T_A = 25°C unless otherwise indicated.



[‡]These parameters are not production tested.

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short-circuit protection control section

DADAMETED	TEST SOMBITIONS	Т			
PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
	T _A = 25°C	650	700	750	
Input threshold voltage (SCP)	T _A = 125°C	400	478	650	mV
	$T_A = MIN$	800	880	950	
Standby voltage (SCP)		140	185	230	mV
	T _A = 25°C		60	120	
Latched input voltage (SCP)	T _A = 125°C		70	120	mV
	$T_A = MIN$		60	120	
Equivalent timing resistance			170		kΩ
Comparator threshold voltage (FEEDBACK)			1.18	·	V

 $^{^{\}dagger}$ All typical values are at TA = 25 $^{\circ}$ C unless otherwise indicated.

oscillator section

D.D.WETED	T-07 0011D1	TEST CONDITIONS			TL1451AQ			
PARAMETER	TEST CONDI				MAX	UNIT		
		T _A = 25°C		200				
Frequency	$C_T = 330 \text{ pF},$ $R_T = 10 \text{ k}\Omega$	T _A = 125°C		195		kHz		
	11 - 10 132	$T_A = MIN$		193				
Standard deviation of frequency	$C_{T} = 330 \text{ pF},$	$R_T = 10 \text{ k}\Omega$		2%				
		T _A = 25°C		1%				
Frequency change with voltage	V _{CC} = 3.6 V to 40 V	T _A = 125°C		1%				
		$T_A = MIN$		3%				
Frequency change with temperature				1.37%	±10% [‡]			

 $^{^{\}dagger}$ All typical values are at T_A = 25°C unless otherwise indicated. ‡ These parameters are not production tested.

dead-time control section

DADAMETED	TEGT COMPLETIONS	TL1451AQ			
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Input bias current (DTC)	T _A = 25°C			1	^
	T _A = MIN and 125°C			3	μΑ
Latch mode (source) current (DTC)		-80	-145		μΑ
	T _A = 25°C	2.3			
Latched input voltage (DTC)	T _A = 125°C	2.22	2.32		V
	T _A = MIN	2.28	2.4		
Input threshold voltage at f = 10 kHz (DTC)	Zero duty cycle		2.05	2.25‡	V
Imput tilleshold voltage at i = 10 km² (DTC)	Maximum duty cycle	1.2‡	1.45		V

[†] All typical values are at T_A = 25°C unless otherwise indicated. ‡ These parameters are not production tested.



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error-amplifier section

242445752	TEST COMPLETE		TI	_1451AQ		
PARAMETER	TEST CONDITIO	ONS	MIN	TYP [†]	MAX	UNIT
		T _A = 25°C			±7	
Input offset voltage	V _O (FEEDBACK) = 1.25 V	T _A = 125°C			±10	mV
		$T_A = MIN$			±12	
		T _A = 25°C			±100	
Input offset current	V _O (FEEDBACK) = 1.25 V	T _A = 125°C			±100	nA
		T _A = MIN			±200	
		T _A = 25°C		160	500	
Input bias current	VO (FEEDBACK) = 1.25 V	T _A = 125°C		100	500	nA
		T _A = MIN		142	700	
Common-mode input voltage range	V _{CC} = 3.6 V to 40 V		1.05 to 1.45			V
		T _A = 25°C	70	80		
Open-loop voltage amplification	$R_F = 200 \text{ k}\Omega$	T _A = 125°C	70	80		dB
		$T_A = MIN$	64	80		
Unity-gain bandwidth				1.5		MHz
Common-mode rejection ratio			60	80		dB
Positive output voltage swing			2			V
Negative output voltage swing					1	V
		T _A = 25°C	0.5	1.6		
Output (sink) current (FEEDBACK)	$V_{ID} = -0.1 \text{ V}, V_{O} = 1.25 \text{ V}$	T _A = 125°C	0.4	1.8		mA
		$T_A = MIN$	0.3	1.7		
		T _A = 25°C	-45	-70		
Output (source) current (FEEDBACK)	$V_{ID} = 0.1 \text{ V}, V_{O} = 1.25 \text{ V}$	T _A = 125°C	-25	-50		μΑ
		$T_A = MIN$	-15	-70		

 $^{^{\}dagger}$ All typical values are at TA = 25 $^{\circ}$ C unless otherwise indicated.

output section

2424455	TEGT COMPITIONS	Т	TL1451AQ		
PARAMETER	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
Collector off-state current	V _O = 50 V			10	μА
Output saturation voltage	T _A = 25°C		1.2	2	
	T _A = 125°C		1.6	2.4	V
	$T_A = MIN$		1.36	2.2	
Short-circuit output current	V _O = 6 V		90		mA

 $^{^{\}dagger}$ All typical values are at T_A = 25°C unless otherwise indicated.

pwm comparator section

DADAMETED	TEST CONDITIONS	TL1451AQ				
PARAMETER	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT	
Input threshold voltage at f = 10 kHz (FEEDBACK)	Zero duty cycle		2.05	2.25 [‡]	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Input threshold voltage at f = 10 kHz (FEEDBACK)	Maximum duty cycle	1.2 [‡]	1.45		V	

[†] All typical values are at T_A = 25°C unless otherwise indicated. ‡ These parameters are not production tested.



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total device

PARAMETER	TEST CONDITIONS	TL1451AQ			UNIT
PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNII
Standby supply current	Off-state		1.3	1.8	mA
Average supply current	$R_T = 10 \text{ k}\Omega$		1.7	2.4	mA

[†] All typical values are at $T_A = 25$ °C unless otherwise indicated.

PARAMETER MEASUREMENT INFORMATION

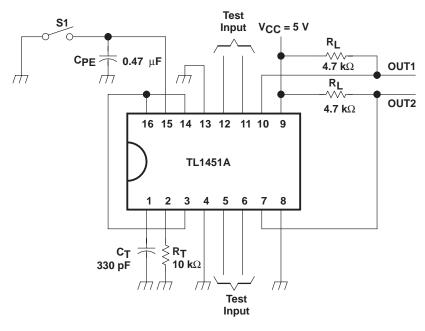
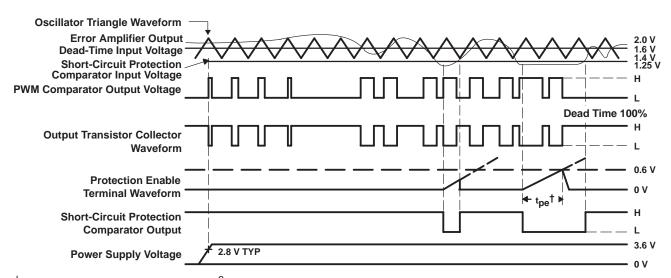


Figure 1. Test Circuit



[†] Protection Enable Time, $t_{pe} = (0.051 \text{ x } 10^6 \text{ x } C_{pe})$ in seconds

Figure 2. TL1451A Timing Diagram



TRIANGLE OSCILLATOR FREQUENCY vs

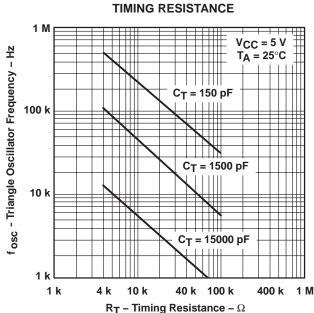


Figure 3

TRIANGLE WAVEFORM SWING VOLTAGE

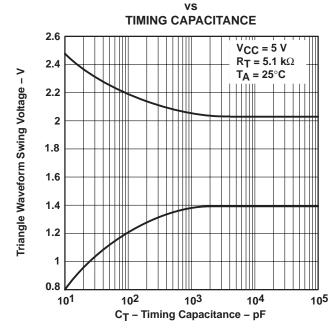


Figure 5

OSCILLATOR FREQUENCY VARIATION vs

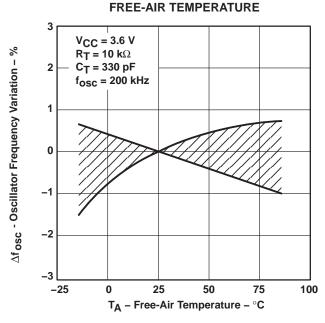


Figure 4

TRIANGLE WAVEFORM PERIOD

TIMING CAPACITANCE

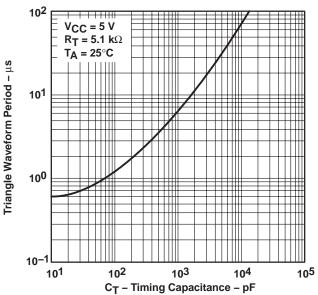


Figure 6



REFERENCE OUTPUT VOLTAGE VARIATION

FREE-AIR TEMPERATURE

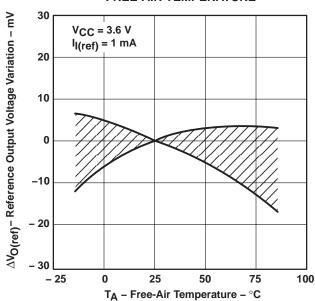


Figure 7

REFERENCE OUTPUT VOLTAGE

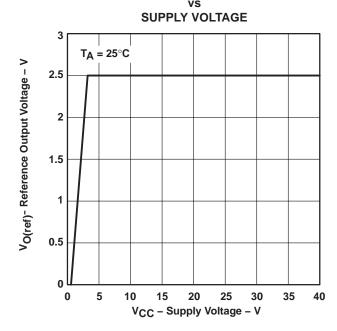


Figure 9

REFERENCE OUTPUT VOLTAGE VARIATION vs

FREE-AIR TEMPERATURE

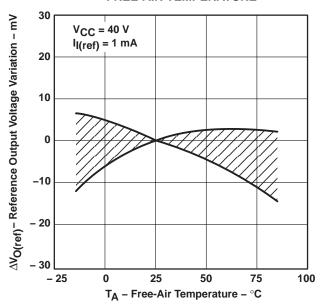


Figure 8

DROPOUT VOLTAGE VARIATION

FREE-TEMPERATURE

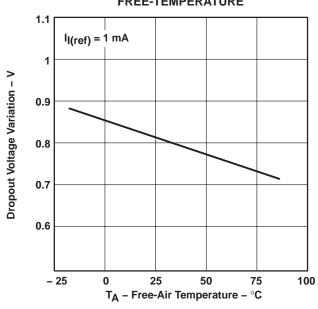
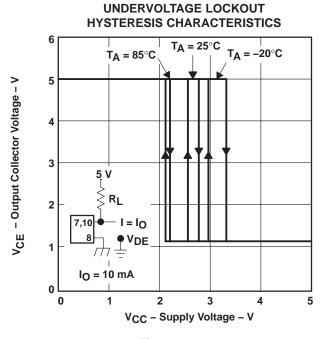


Figure 10





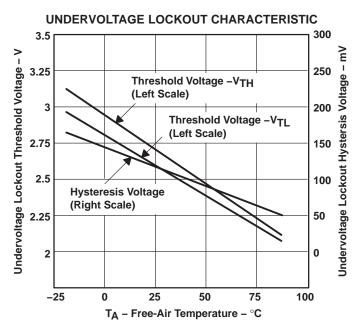


Figure 11

Figure 12

SHORT-CIRCUIT PROTECTION CHARACTERISTICS

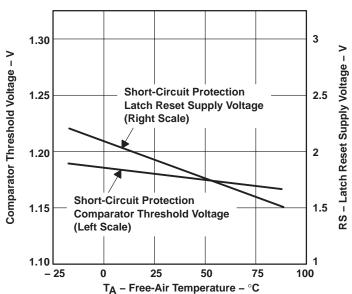
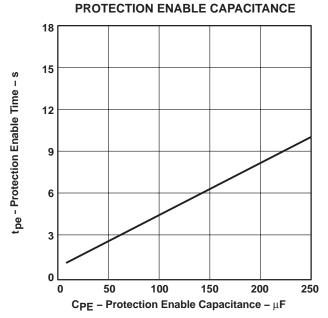


Figure 13

PROTECTION ENABLE TIME vs



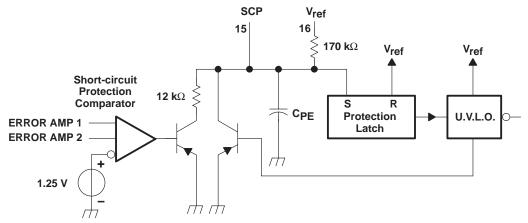
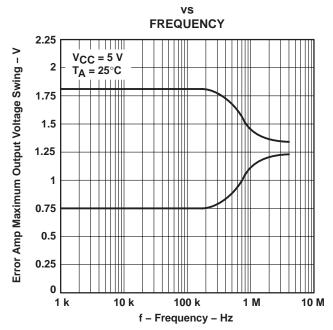


Figure 14

ERROR AMP MAXIMUM OUTPUT VOLTAGE SWING



OPEN-LOOP VOLTAGE AMPLIFICATION

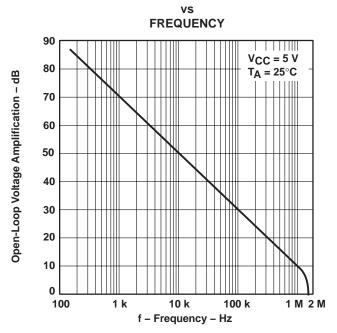


Figure 15

Figure 16

GAIN (AMPLIFIER IN UNITY-GAIN CONFIGURATION)

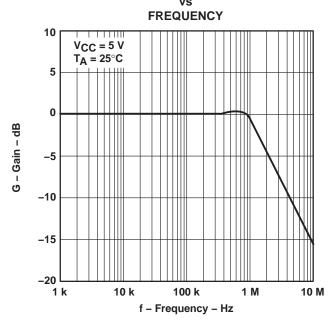
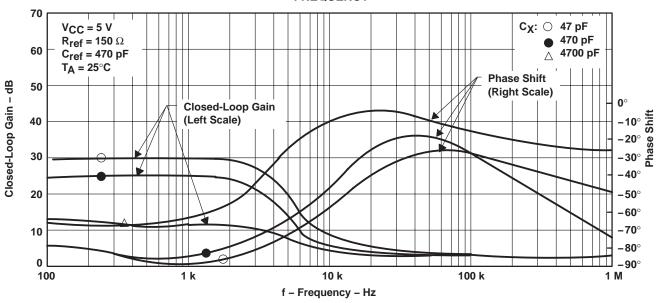


Figure 17



CLOSED-LOOP GAIN AND PHASE SHIFT

vs FREQUENCY



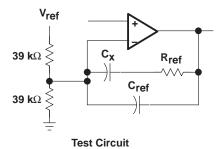


Figure 18

CLOSED-LOOP GAIN AND PHASE SHIFT

FREQUENCY 70 V_CC = 5 V C_X: ○ 47 pF • 470 pF R_{ref} = 15 Ω 60 $C_{ref} = 470 pF$ △ 4700 pF T_A = 25°C **Phase Shift** Closed-Loop Gain - dB 50 (Right Scale) Closed-Loop Gain -10° 01--20° -30° -40 (Left Scale) 30 -40° 20 -50° -60° $\boldsymbol{-70^{\circ}}$ 10 -80° 0 -90° 100 1 k 10 k 100 k 1 M f - Frequency - Hz

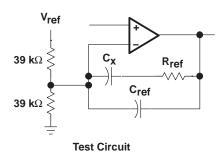
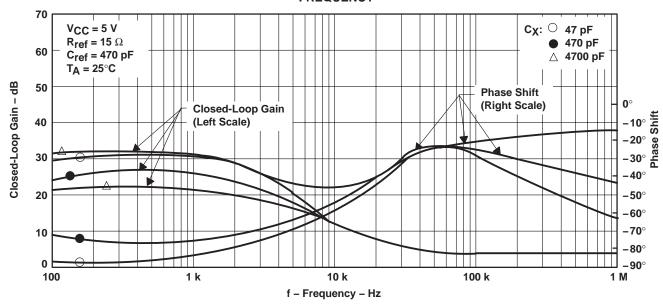


Figure 19

CLOSED-LOOP GAIN AND PHASE SHIFT

FREQUENCY



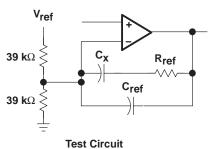
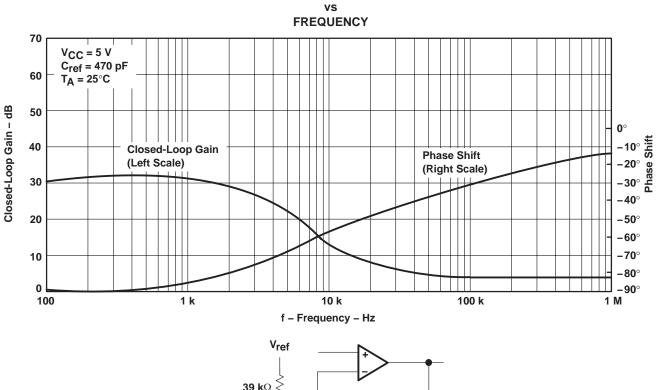


Figure 20

CLOSED-LOOP GAIN AND PHASE SHIFT



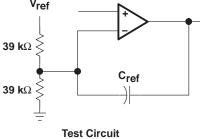


Figure 21

OUTPUT SINK CURRENT

COLLECTOR OUTPUT SATURATION VOLTAGE

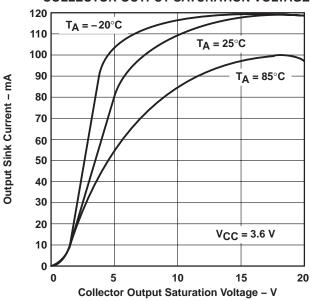


Figure 22

MAXIMUM OUTPUT VOLTAGE SWING

V5

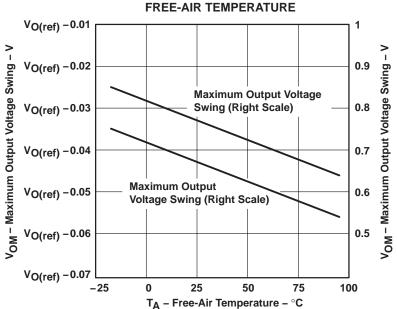
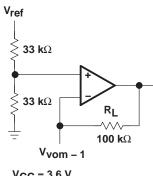


Figure 23



 $\begin{array}{l} V_{CC} = 3.6 \ V \\ R_L = 100 \ k\Omega \\ V_{OM+1} = 1.25 \ V \\ V_{OM} \ _{-1} = 1.15 \ V \ (Right Scale) \\ V_{OM} \ _{-1} = 1.35 \ V \ (Left Scale) \end{array}$

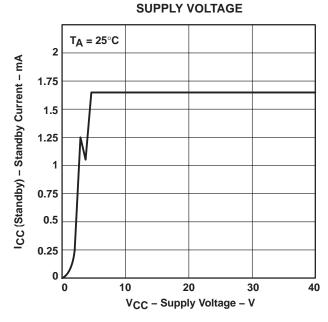
TEST CIRCUIT



OUTPUT TRANSISTOR ON DUTY CYCLE DEAD-TIME INPUT VOLTAGE 0 $V_{CC} = 3.6 V$ 10 $R_T = 10k\Omega$ Output Transistor "On" Duty Cycle - % $C_T = 330 pF$ 20 30 40 50 60 70 90 100 0.5 2 3.5 Dead-Time Input Voltage - V

Figure 24

STANDBY CURRENT FREE-AIR TEMPERATURE **Average Supply Current** 2 $V_{CC} = 6 \text{ V}, R_T = 10 \text{ k}\Omega,$ $C_{T} = 330 \text{ pF}$ 1.75 ICC - Supply Current - mA 1.5 Stand-By Current, V_{CC} = 40 V, No Load 1.25 Stand-By Current, V_{CC} = 3.6 V, No Load 1 0.75 0.5 0.25 0 -25 100 T_A - Free-Air Temperature - °C Figure 26



STANDBY CURRENT

Figure 25

MAXIMUM CONTINUOUS POWER DISSIPATION

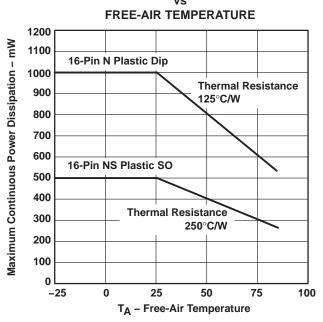


Figure 27

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VCC 150 Ω **220 k**Ω } **L1 ≶470** Ω 33 k Ω 330 pF **R**1≶ R3 **33 k**Ω ≷ C2 Step-Up Output R2 **33 k**Ω ≥ R4 33 $k\Omega$ C1 500 pF V_{ref} 16 15 14 13 12 11 10 TL1451A **≤470** Ω **470** Ω \$

APPLICATION INFORMATION

NOTE A: Values for R1 through R7, C1 through C4, and L1 and L2 depend upon individual application.

470 Ω

500

§ 33 kΩ

≶**R**5

C5 💳

33 $\mathbf{k}\Omega$

Figure 28. High-Speed Dual Switching Regulator

220 Ω

L2

R6 ≶

R7

Step-Down Output





PACKAGE OPTION ADDENDUM

27-Feb-2006

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Pa	ckage Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TL1451AQPWRQ1	ACTIVE	TSSOP	PW	16 2	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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